

EAST Search History

EAST Search History (Prior Art)

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|-------|--|---|------------------|---------|---------------------|
| L1 | 1 | "20040011288".pn. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/07 17:13 |
| S1 | 1 | ("6548121").PN. | USPAT; USOCR | OR | OFF | 2009/02/19 16:58 |
| S2 | 1180 | "ciba specialty chemicals corporation".as. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/19 18:03 |
| S3 | 5 | "ciba specialty chemicals corporation".as. and strongly adherent coatings | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/19 18:04 |
| S4 | 5 | "ciba specialty chemicals corporation".as. and strongly adherent coating | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/19 18:04 |
| S5 | 1 | 10/566743.app. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/19 18:37 |
| S6 | 1 | ("7455891").PN. | USPAT; USOCR | OR | OFF | 2009/02/20 11:00 |
| S7 | 8 | ((("7455891") or ("6251963") or ("6486228") or ("6515051") or ("6803392") or ("6733847") or ("6548121") or ("6368362")).PN. | USPAT; USOCR | OR | OFF | 2009/02/20 11:09 |
| S8 | 9 | ((("7455891") or ("6251963") or ("6486228") or ("6515051") or ("6803392") or ("6733847") or ("6548121") or ("6368362") or ("6399805")).PN. | USPAT; USOCR | OR | OFF | 2009/02/20 11:14 |
| S9 | 108 | ("3669951" "3936305" "4082679" "4199421" "4226763" "4246315" "4275004" "4278589" "4292152" "4298738" "4315848" "4324744" "4347180" "4385109" "4466993" "4533652" "4567106" "4681905" "4684679" "4684680" "4710523" "4737593" "4792632" "4861916" "4868246" "4965294" "4990364" "5053246" "5080994" "5106891" "5108835" "5116534" "5153284" "5166355" "5168087" "5196142" "5218009" "5250698" "5252403" "5278314" "5280124" "5292890" "5330539" "5360850" "5399770" "5436349" "5456728" "5472992" "5504236" "5516914" "5549847" "5554760" "5563242" "5574166" "5607987" "5646088" "5935900" "5942290" "5955514" "5990189" "6099122" "6190423" "6329445" "6344505" "6361925" "6376065" "6399805" "6407254" "6548121" "6733847").PN. OR ("6251963" "6368362" "6399805" "6486228" "6515051" "6548121" "6733847" "6803392" "7455891").URPN. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2009/02/20 11:21 |
| S10 | 15 | ("4199421" "4246315" "4466993" "4567106" "4990364" "5053246" "5252403" "6099122" "6548121" "6733847").PN. OR ("6548121" "6733847" "7455891").URPN. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2009/02/20 11:22 |
| S11 | 21169 | 427/533,535,536,517,407.1-412.5,532-559,517,509,512,513,517,518,519,520,535,536,538,551,553,554,556,407.2,409,412,412.1,419,2.cds. or 430/311.cds. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 11:27 |

| | | | | | | |
|-----|------|--|---|-----|----|---------------------|
| S12 | 5299 | 427/533,509.ccls. or 430/311.ccls. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 11:27 |
| S13 | 211 | (adhere\$4 or adhesion or glu\$3 or bond\$3) with metallized with (organic or polymer) with substrate | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 12:30 |
| S14 | 139 | (adhere\$4 or adhesion or glu\$3 or bond\$3) with metallized with (organic or polymer) with substrate and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 12:30 |
| S15 | 13 | (adhere\$4 or adhesion or glu\$3 or bond\$3) with metallized with (organic or polymer) with substrate and @PY<"2004" and S11 | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 12:30 |
| S16 | 7 | circuit and photoinitiator with adhesion with metal | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 16:56 |
| S17 | 183 | circuit and photoinitiator with adhesion and (metal or copper) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:11 |
| S18 | 13 | circuit and photoinitiator with adhesion with (metal or copper) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:11 |
| S19 | 613 | circuit and photoresist with adhesion with (metal or copper) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:18 |
| S20 | 283 | circuit and photoresist with adhesion with (metal or copper) and plasma | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:18 |
| S21 | 47 | circuit and photoresist with adhesion with (metal or copper) with plasma | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:19 |
| S22 | 0 | solder mask with (photopolymerizable or photoresist or photoinitiator or light sensitive or crosslink\$3 or UV) with adhesion with (metal or copper) with plasma | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:34 |

| | | | | | | |
|-----|-------|---|---|-----|----|---------------------|
| S23 | 0 | solder mask with (photopolymerizable or photoresist or photoinitiator or light sensitive or crosslink\$3 or UV) and adhesion with (metal or copper) with plasma | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:34 |
| S24 | 1116 | solder mask with (photopolymerizable or photoresist or photoinitiator or light sensitive or crosslink\$3 or UV) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:35 |
| S25 | 46 | solder mask with (photopolymerizable or photoresist or photoinitiator or light sensitive or crosslink\$3 or UV) with adhesion | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:35 |
| S26 | 10 | solder mask with UV with adhesion | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:40 |
| S27 | 2 | "20030129322".did. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 17:42 |
| S28 | 13 | solder mask with (cvd or evaporate or pvd) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:38 |
| S29 | 692 | solder with (cvd or evaporate or pvd) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:41 |
| S30 | 5 | solder with (cvd or evaporate or pvd) with (photopolymerizable or UV or photoinitiator or photoresist) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:43 |
| S31 | 149 | solder with (cvd or evaporate or pvd) and (photopolymerizable or UV or photoinitiator or photoresist) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:44 |
| S32 | 12645 | metal with (cvd or evaporate or pvd) and (photopolymerizable or UV or photoinitiator or photoresist) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:44 |
| S33 | 45 | solder with (cvd or evaporate or pvd) and (photopolymerizable or UV or photoinitiator or photoresist) and @PY< "2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:44 |

| | | | | | | |
|-----|-----|--|---|-----|-----|---------------------|
| S34 | 580 | circuit board and (metal or solder or contact or electrode or copper) with (cvd or evaporate or pvd) and (photopolymerizable or UV or photoinitiator or photoresist) and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:57 |
| S35 | 25 | circuit board and (metal or solder or contact or electrode or copper) with (cvd or evaporate or pvd) with (photopolymerizable or UV or photoinitiator or photoresist) and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:57 |
| S36 | 3 | wiring board and (metal or solder or contact or electrode or copper) with (cvd or evaporate or pvd) with (photopolymerizable or UV or photoinitiator or photoresist) and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 18:58 |
| S37 | 121 | circuit board and (metal or solder or contact or electrode or copper) with (cvd or evaporate or pvd) and (photopolymerizable or UV or photoinitiator or photoresist) and @PY<"2004" and cmp | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/20 19:05 |
| S38 | 1 | ("6524950").PN. | USPAT; USOCR | OR | OFF | 2009/02/20 19:21 |
| S39 | 600 | photoresist with (lift off or liftoff) and polymer\$2 with substrate and metal | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 12:24 |
| S40 | 189 | photoresist with (lift off or liftoff) and polymer\$2 with substrate and metal and @PY<"2003" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 12:24 |
| S41 | 12 | photoresist with (lift off or liftoff) and polymer\$2 with substrate and metal and develop\$3 with (solvent or mechanical\$3)and dry with (oven or IR or hot gas\$2 or microwave or roller) and @PY<"2003" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 12:25 |
| S42 | 0 | photoresist with (lift off or liftoff) and flexible with substrate and metal and develop\$3 with (solvent or mechanical\$3)and dry with (oven or IR or hot gas\$2 or microwave or roller) and @PY<"2003" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 12:34 |
| S43 | 0 | photoresist with (lift off or liftoff) and flexible with substrate and metal and develop\$3 with (solvent or mechanical\$3)and dry with (oven or IR or hot gas\$2 or microwave or roller) and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 12:34 |
| S44 | 73 | photoresist with (lift off or liftoff) and flexible with substrate and metal and develop\$3 and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 12:34 |

| | | | | | | |
|-----|------|--|---|-----|----|---------------------|
| S45 | 1721 | (lithography or photoresist) with (lift off or liftoff) and (polymer\$2 or metal\$3 or glass or metal oxide) with substrate and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 13:42 |
| S46 | 132 | (lithography or photoresist) with (lift off or liftoff) and (polymer\$2 or metal\$3 or glass or metal oxide) with substrate and (sputter or evaporate) with (metal or half-metal) and @PY<"2004" | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 13:43 |
| S47 | 265 | 427/98.5.ccls. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 14:01 |
| S48 | 95 | 427/98.5.ccls. and (resist or photoinitiator) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 14:02 |
| S49 | 26 | 427/98.5.ccls. and (resist or photoinitiator) and plasma | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 14:03 |
| S50 | 2 | 10/502208.app. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/23 15:36 |
| S51 | 1 | trimethylbenzoyl allyl phenyl phosphine oxide | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/24 13:17 |
| S52 | 12 | ("20020026049" "20050147919" "6399805" "6548121" "6589550" "6733847").PN. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/25 12:09 |
| S53 | 2 | (09/871373 10/502208).APP. | USPAT; USOCR | ADJ | ON | 2009/02/25 12:10 |
| S54 | 1 | wo-0024527-\$.did. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/02/25 14:05 |
| S55 | 0 | EP-0475592-\$.did. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/03/24 12:27 |

| | | | | | | |
|-----|------|---|---|-----|----|---------------------|
| S56 | 0 | EP-0475592.dld. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/03/24 12:27 |
| S57 | 0 | EP0475592.dld. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/03/24 12:27 |
| S58 | 2 | "US 20060257681" | US-PGPUB; USPAT; USOCR; DERWENT | ADJ | ON | 2010/03/24 14:32 |
| S59 | 22 | radiation with curing with dosage with crosslinking | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/03/24 15:58 |
| S60 | 98 | primer with photoinitiator with (irradiat\$3 or cur\$3 or crosslink\$3) | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/01 11:44 |
| S61 | 2 | jp-2001083301-\$.dld. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/01 12:23 |
| S62 | 1 | 2001-338377.NRAN. | DERWENT | ADJ | ON | 2010/04/01 12:24 |
| S63 | 1 | 2001-338377.NRAN. | DERWENT | ADJ | ON | 2010/04/01 12:24 |
| S64 | 150 | 427/492.ccls. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/01 17:08 |
| S65 | 655 | 427/487.ccls. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/01 17:24 |
| S66 | 1148 | 427/508.ccls. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/01 17:27 |
| S67 | 775 | 427/510.ccls. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/01 17:27 |

| | | | | | | |
|-----|------|--|---|-----|-----|---------------------|
| S68 | 748 | 427/517-519.cds. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM TDB | ADJ | ON | 2010/04/01 17:27 |
| S69 | 115 | 427/517-519.cds. and primer | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM TDB | ADJ | ON | 2010/04/01 17:27 |
| S70 | 1 | ("4,634,602").PN. | USPAT; USOCR | OR | OFF | 2010/04/02 08:51 |
| S71 | 31 | ("3876432" "3899611" "4025407" "4128600" "4169732" "4205018" "4295947" "4342793" "4374963" "4391855" "4425207").PN. OR ("4634602").URPN. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 09:01 |
| S77 | 15 | ("2873241" "3036930" "3892575" "4303697").PN. OR ("4778724").URPN. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 10:34 |
| S78 | 15 | ("2873241" "3088791" "3131138" "3453195").PN. OR ("3892885").URPN. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 11:25 |
| S79 | 23 | ("3661614" "4188451" "4190681" "4197335" "4198465" "4218294" "4222835" "4264658" "4384026" "4396678").PN. OR ("4902578").URPN. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 15:51 |
| S81 | 0 | DE-19953433-\$.did. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 16:55 |
| S82 | 0 | DE-1995003433-\$.did. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 16:56 |
| S83 | 0 | DE-95003433-\$.did. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 16:56 |
| S84 | 0 | DE-953433-\$.did. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 16:56 |
| S85 | 1611 | 427/508-510.cds. | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 17:00 |
| S86 | 204 | 427/508-510.cds. and metal\$4 and primer | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 17:01 |
| S87 | 148 | 427/508-510.cds. and metal\$4 with (coating or layer or film) and primer | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/02 17:01 |
| S88 | 7 | 427/508-510.cds. and metal\$4 with (coating or layer or film) and primer with (\$5initiator) with (cur\$3 or crosslink\$3) | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 15:48 |
| S89 | 8 | 427/508-510.cds. and metal\$4 and primer with (\$5initiator) with (cur\$3 or crosslink\$3) | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 15:51 |
| S90 | 185 | 427/508-510.cds. and metal\$4 with substrate and (\$5initiator) with (cur\$3 or crosslink\$3) | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 15:51 |
| S91 | 0 | 427/508-510.cds. and metal\$4 with substrate and (multicoat\$3 or multilayer) and (\$5initiator) with cur\$3 with uncur\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 16:41 |
| S92 | 2 | 427/508-510.cds. and (multicoat\$3 or multilayer) and (\$5initiator) with cur\$3 with uncur\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 16:41 |
| S93 | 2 | 427/508-510.cds. and (multicoat\$3 or multilayer) and (\$5initiator) with cur\$3 with (stable) | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 16:42 |
| S94 | 57 | 427/508-510.cds. and (multicoat\$3 or multilayer) and photoinitiator with cur\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 16:42 |
| S95 | 49 | 427/508-510.cds. and (multicoat\$3 or multilayer) and photoinitiator with cur\$3 and metal\$4 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 16:43 |

| | | | | | | |
|------|-----|---|---|-----|----|---------------------|
| S96 | 0 | 427/508-510.ccls. and (multicoat\$3 or multilayer) and photoinitiator with partial\$2 cur\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:20 |
| S97 | 2 | 427/508-510.ccls. and photoinitiator with partial\$2 cur\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:20 |
| S98 | 4 | 427/508-510.ccls. and photoinitiator with partial\$2 near5 cur\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:20 |
| S99 | 5 | 427/508-510.ccls. and partial\$2 near5 cur\$3 with unsaturated | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:20 |
| S100 | 195 | 427/508-510.ccls. and partial\$2 near5 cur\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:23 |
| S101 | 109 | 427/508-510.ccls. and partial\$2 near5 cur\$3 and photoinitiator | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:23 |
| S102 | 151 | 427/508-510.ccls. and partial\$2 near5 cur\$3 and metal\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:23 |
| S103 | 148 | 427/508-510.ccls. and metal\$4 with (coating or layer or film) and primer | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:24 |
| S104 | 126 | 427/508-510.ccls. and partial\$2 near5 cur\$3 and metal\$3 not S103 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:24 |
| S105 | 22 | 427/508-510.ccls. and partial\$2 near5 cur\$3 and metal\$3 not S103 and multilayer | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:24 |
| S106 | 23 | 427/508-510.ccls. and partial\$2 near5 cur\$3 and metal\$3 not S103 and multilayer\$3 | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/05 17:24 |
| S107 | 1 | wo-0232201-\$.did. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/07 09:32 |
| S108 | 2 | jp-2001217529-\$.did. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/07 09:42 |
| S109 | 2 | jp-2001046940-\$.did. | US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2010/04/07 09:46 |
| S110 | 1 | 2001-567393.NRAN. | DERWENT | ADJ | ON | 2010/04/07 09:48 |
| S111 | 5 | 427/508-510.ccls. and metal\$3 with (evaporat\$3 or sputter\$3) and multilayer\$3 and ("UV/VIS" or UV or ultraviolet) with cur\$4 and photoinitiator and acrylate | US-PGPUB; USPAT; USOCR | ADJ | ON | 2010/04/07 13:57 |

EAST Search History (Interference)

< This search history is empty >

4/ 7/ 2010 5:17:43 PM

C:\ Documents and Settings\ jhoring\ My Documents\ EAST\ Workspaces\ 10556609.wsp